LM101AQML Operational Amplifiers

Check for Samples: LM101AQML

FEATURES

- **Available with Radiation Guarantee**
- **Offset Voltage 3 mV Maximum Over Temperature**
- **Input Current 100 nA Maximum Over Temperature**
- **Offset Current 20 nA Maximum Over Temperature**
- **Ensured Drift Characteristics**
- **Offsets Specified Over Entire Common Mode and Supply Voltage Ranges**
- **Slew Rate of 10 V/µS as a Summing Amplifier**

DESCRIPTION

The LM101A is a general purpose operational amplifier which features improved performance over industry standards such as the LM709. Advanced processing techniques make possible an order of magnitude reduction in input currents, and a redesign of the biasing circuitry reduces the temperature drift of input current. Improved specifications include:

- Offset voltage 3 mV maximum over temperature
- Input current 100 nA maximum over temperature
- Offset current 20 nA maximum over temperature
- Specified drift characteristics
- Offsets ensured over entire common mode and supply voltage ranges
- Slew rate of 10V/µs as a summing amplifier
    - This amplifier offers many features which make its application nearly foolproof: overload protection on the input and output, no latch-up when the common mode range is exceeded, and freedom from oscillations and compensation with a single 30 pF capacitor. It has advantages over internally compensated amplifiers in that the frequency compensation can be tailored to the particular application. For example, in low frequency circuits it can be overcompensated for increased stability margin. Or the compensation can be optimized to give more than a factor of ten improvement in high frequency performance for most applications.
    - In addition, the device provides better accuracy and lower noise in high impedance circuitry. The low input currents also make it particularly well suited for long interval integrators or timers, sample and hold circuits and low frequency waveform generators. Further, replacing circuits where matched transistor pairs buffer the inputs of conventional IC op amps, it can give lower offset voltage and a drift at a lower cost.

⚠️ Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.
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These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.
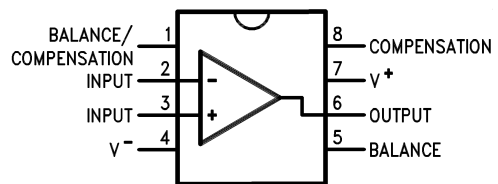
Schematic
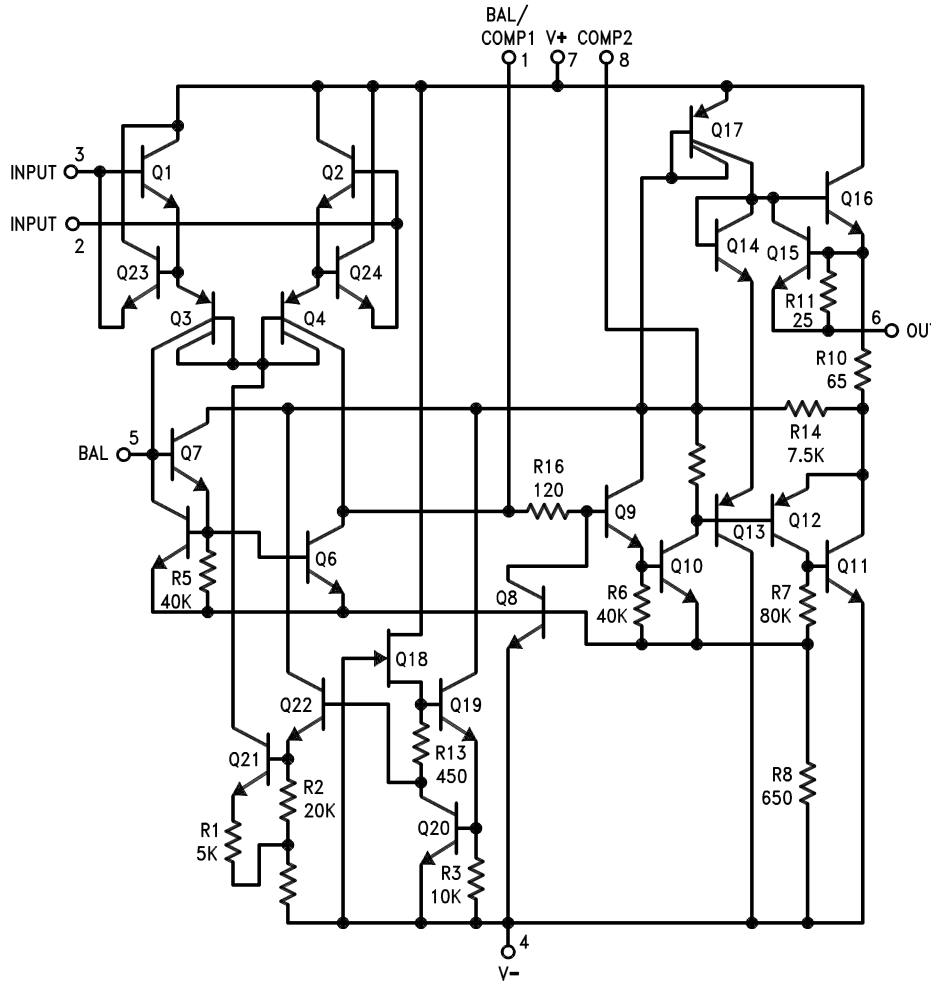
Pin connections shown are for 8-pin packages.
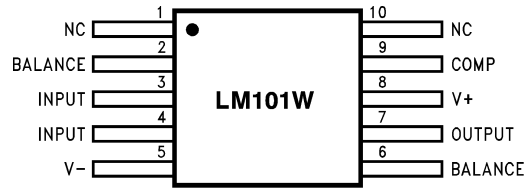
Connection Diagrams

Note: Pin 4 connected to case.
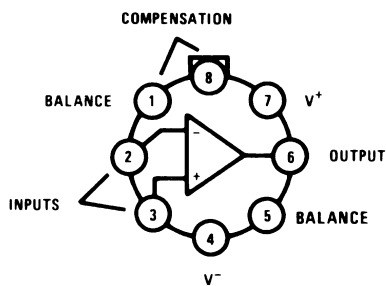
Figure 1. TO Package (Top View)
See Package Number LMC0008C
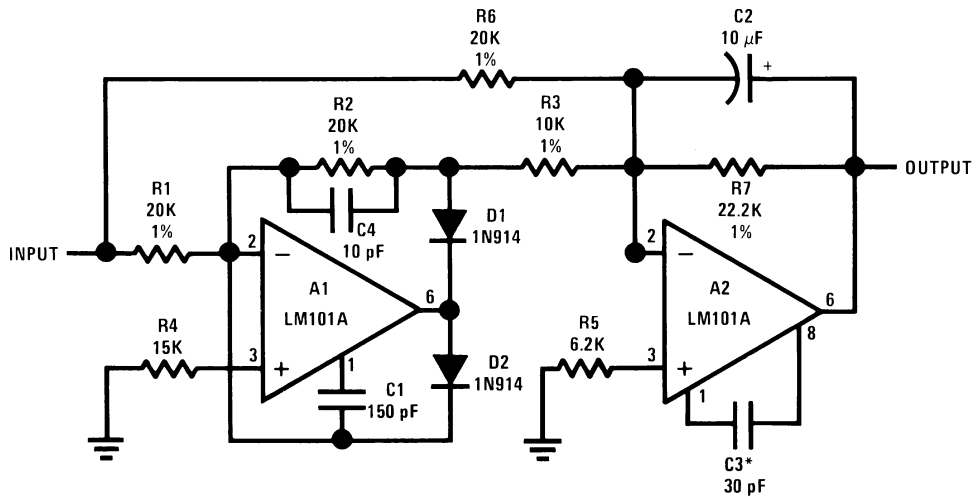

Figure 2. CDIP Package (Top View)
See Package Number NAB0008A

Figure 3. CLGA Package (Top View)
See Package Number NAD0010A

Fast AC/DC Converter

Note: Feedforward compensation can be used to make a fast full wave rectifier without a filter.

Product Folder Links: *LM101AQML*

LM101AQML

Absolute Maximum Ratings[1]

Supply Voltage			±22V
Differential Input Voltage			±30V
Input Voltage[2]			±15V
Output Short Circuit Duration			Continuous
Operating Ambient Temp. Range			−55°C ≤ T_A ≤ +125°C
T_J Max			150°C
Power Dissipation at T_A = 25°C[3]	LMC-Package	(Still Air)	750 mW
		(500 LF / Min Air Flow)	1200 mW
	NAB-Package	(Still Air)	1000 mW
		(500 LF / Min Air Flow)	1500 mW
	NAD-Package	(Still Air)	500mW
		(500 LF / Min Air Flow)	800mW
Thermal Resistance	θ_{JA}	LMC-Package	(Still Air)	165°C/W
			(500 LF / Min Air Flow)	89°C/W
		NAB-Package	(Still Air)	128°C/W
			(500 LF / Min Air Flow)	75°C/W
		NAD-Package	(Still Air)	233°C/W
			(500 LF / Min Air Flow)	155°C/W
	θ_{JC} (Typical)	LMC-Package		39°C/W
		NAB-Package		26°C/W
		NAD-Package		26°C/W
Storage Temperature Range			−65°C ≤ T_A ≤ +150°C
Lead Temperature (Soldering, 10 sec.)			300°C
ESD Tolerance[4]			3000V

(1) Absolute Maximum Ratings indicate limits beyond which damage to the device may occur. Operating ratings indicate conditions for which the device is intended to be functional, but do no ensure specific performance limits. For ensured specifications and test conditions, see the Electrical Characteristics. The specifications apply only for the test conditions listed. Some performance characteristics may degrade when the device is not operated under the listed test conditions.
(2) For supply voltages less than ±15V, the absolute maximum input voltage is equal to the supply voltage.
(3) The maximum power dissipation must be derated at elevated temperatures and is dictated by T_{Jmax} (maximum junction temperature), θ_{JA} (package junction to ambient thermal resistance), and T_A (ambient temperature). The maximum allowable power dissipation at any temperature is $P_{Dmax} = (T_{Jmax} − T_A) / \theta_{JA}$ or the number given in the Absolute Maximum Ratings, whichever is lower.
(4) Human body model, 100 pF discharged through 1.5 kΩ.

Quality Conformance Inspection

Mil-Std-883, Method 5005 - Group A

Subgroup	Description	Temp (°C)
1	Static tests at	25
2	Static tests at	125
3	Static tests at	-55
4	Dynamic tests at	25
5	Dynamic tests at	125
6	Dynamic tests at	-55
7	Functional tests at	25
8A	Functional tests at	125
8B	Functional tests at	-55
9	Switching tests at	25
10	Switching tests at	125
11	Switching tests at	-55

LM101A   883 Electrical Characteristics DC Parameters

The following conditions apply to all parameters, unless otherwise specified
$V_{CC} = \pm20V$, $V_{CM} = 0V$

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub-groups
V_{IO}	Input Offset Voltage	V_{CM} = -15V, R_S = 50Ω		-2.0	2.0	mV	1
				-3.0	3.0	mV	2, 3
		V_{CM} = 15V, R_S = 50Ω		-2.0	2.0	mV	1
				-3.0	3.0	mV	2, 3
		R_S = 50Ω		-2.0	2.0	mV	1
				-3.0	3.0	mV	2, 3
		V_{CC} = ±5V, R_S = 50Ω		-2.0	2.0	mV	1
				-3.0	3.0	mV	2, 3
I_{IO}	Input Offset Current	V_{CM} = -15V		-10	10	nA	1
				-20	20	nA	2, 3
		V_{CM} = 15V		-10	10	nA	1
				-20	20	nA	2, 3
				-10	10	nA	1
				-20	20	nA	2, 3
		V_{CC} = ±5V		-10	10	nA	1
				-20	20	nA	2, 3
$\pm I_{IB}$	Input Bias Current	V_{CM} = -15V		1.0	75	nA	1
				1.0	100	nA	2, 3
		V_{CM} = 15V		1.0	75	nA	1
				1.0	100	nA	2, 3
				1.0	75	nA	1
				1.0	100	nA	2, 3
		V_{CC} = ±5V		1.0	75	nA	1
				1.0	100	nA	2, 3
PSRR+	Power Supply Rejection Ratio	+V_{CC} = +20V and +5V, -V_{CC}=-20V, R_S=50Ω		80		dB	1, 2, 3
PSRR-	Power Supply Rejection Ratio	+V_{CC} = +20V, -V_{CC}= -20V and -5V, R_S=50Ω		80		dB	1, 2, 3
CMRR	Common Mode Rejection Ratio	-15V ≤ V_{CM} ≤ 15V, R_S = 50Ω		80		dB	1, 2, 3
I_{CC}	Supply Current				3.0	mA	1
					2.5	mA	2
					3.5	mA	3
+V_{IO} Adj	Input Offset Voltage Adjust			4.0		mV	1, 2, 3
−V_{IO} Adj	Input Offset Voltage Adjust				-4.0	mV	1, 2, 3
+I_{OS}	Short Circuit Current			-45	-7.0	mA	1, 2, 3
-I_{OS}	Short Circuit Current			7.0	45	mA	1, 2, 3
V_I	Input Voltage Range	V_{CC} = ±20V	See[1]	-15	15	V	1, 2, 3
+A_{VS}	Large Signal Gain	V_{CC} = ±15V, R_S = 0, R_L=2KΩ, V_O =10V		50		V/mV	4
				25		V/mV	5, 6
-A_{VS}	Large Signal Gain	V_{CC} = ±15V, R_S = 0, R_L=2KΩ, V_O =-10V		50		V/mV	4
				25		V/mV	5, 6
R_I	Input Resistance		See[2]	1.5		MΩ	4
			see[2]	0.5		MΩ	5, 6

(1)   Parameter specified by the input conditions of several DC parameters
(2)   Parameter specified by design, not tested.

LM101A   883 Electrical Characteristics DC Parameters (continued)

The following conditions apply to all parameters, unless otherwise specified
$V_{CC} = \pm 20V$, $V_{CM} = 0V$

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub-groups
$+V_{OP}$	Output Voltage Swing	$R_L = 10K\Omega$		16		V	4, 5, 6
		$R_L = 2K\Omega$		15		V	4, 5, 6
		$R_L = 10K\Omega$, $V_{CC} = \pm 15V$		12		V	4, 5, 6
		$R_L = 2K\Omega$, $V_{CC} = \pm 15V$		10		V	4, 5, 6
$-V_{OP}$	Output Voltage Swing	$R_L = 10K\Omega$			-16	V	4, 5, 6
		$R_L = 2K\Omega$			-15	V	4, 5, 6
		$R_L = 10K\Omega$, $V_{CC} = \pm 15V$			-12	V	4, 5, 6
		$R_L = 2K\Omega$, $V_{CC} = \pm 15V$			-10	V	4, 5, 6

LM101A   883 Electrical Characteristics AC Parameters

The following conditions apply to all parameters, unless otherwise specified
$V_{CC} = \pm 20V$, $R_L = 2K\Omega$, $A_V = 1$

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub-groups
+SR	Slew Rate	$V_I = -5V$ to $5V$			0.2	V/µS	7
-SR	Slew Rate	$V_I = 5V$ to $-5V$			0.2	V/µS	7
G_{BW}	Gain Bandwidth	$V_I = 50mV_{RMS}$, $f = 20KHz$			0.25	MHz	7

LM101A   QML and RH Electrical Characteristics[1] DC Parameters

The following conditions apply to all parameters, unless otherwise specified
$V_{CC} = \pm 20V$, $V_{CM} = 0V$, $R_S = 50\Omega$

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub-groups
V_{IO}	Input Offset Voltage	$+V_{CC} = 35V$, $-V_{CC} = -5V$, $V_{CM} = -15V$		-2.0	+2.0	mV	1
				-3.0	+3.0	mV	2, 3
		$+V_{CC} = 5V$, $-V_{CC} = -35V$, $V_{CM} = +15V$		-2.0	+2.0	mV	1
				-3.0	+3.0	mV	2, 3
		$V_{CM} = 0V$		-2.0	+2.0	mV	1
				-3.0	+3.0	mV	2, 3
		$+V_{CC} = 5V$, $-V_{CC} = -5V$, $V_{CM} = 0V$		-2.0	+2.0	mV	1
				-3.0	+3.0	mV	2, 3
I_{IO}	Input Offset Current	$+V_{CC} = 35V$, $-V_{CC} = -5V$, $V_{CM} = -15V$, $R_S = 100K\Omega$		-10	+10	nA	1, 2
				-20	+20	nA	3
		$+V_{CC} = 5V$, $-V_{CC} = -35V$, $V_{CM} = +15V$, $R_S = 100K\Omega$		-10	+10	nA	1, 2
				-20	+20	nA	3
		$V_{CM} = 0V$, $R_S = 100K\Omega$		-10	+10	nA	1, 2
				-20	+20	nA	3
		$+V_{CC} = 5V$, $-V_{CC} = -5V$, $V_{CM} = 0V$, $R_S = 100K\Omega$		-10	+10	nA	1, 2
				-20	+20	nA	3

(1)   Pre and post irradiation limits are identical to those listed under AC and DC electrical characteristics. These parts may be dose rate sensitive in a space environment and demonstrate enhanced low dose rate effect. Radiation end point limits for the noted parameters are specified only for the conditions as specified in Mil-Std-883, Method 1019

Product Folder Links: *LM101AQML*

LM101A   QML and RH Electrical Characteristics[1] DC Parameters (continued)

The following conditions apply to all parameters, unless otherwise specified
$V_{CC} = \pm20V$, $V_{CM} = 0V$, $R_S = 50\Omega$

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub-groups
$\pm I_{IB}$	Input Bias Current	$+V_{CC} = 35V$, $-V_{CC} = -5V$, $V_{CM} = -15V$, $R_S = 100K\Omega$		-0.1	75	nA	1, 2
				-0.1	100	nA	3
		$+V_{CC} = 5V$, $-V_{CC} = -35V$, $V_{CM} = +15V$, $R_S = 100K\Omega$		-0.1	75	nA	1, 2
				-0.1	100	nA	3
		$V_{CM} = 0V$, $R_S = 100K\Omega$		-0.1	75	nA	1, 2
				-0.1	100	nA	3
		$+V_{CC} = 5V$, $-V_{CC} = -5V$, $V_{CM} = 0V$, $R_S = 100K\Omega$		-0.1	75	nA	1, 2
				-0.1	100	nA	3
+PSRR	Power Supply Rejection Ratio	$+V_{CC} = 10V$, $-V_{CC} = -20V$		-50	+50	µV/V	1
				-100	+100	µV/V	2, 3
-PSRR	Power Supply Rejection Ratio	$+V_{CC} = 20V$, $-V_{CC} = -10V$		-50	+50	µV/V	1
				-100	+100	µV/V	2, 3
CMRR	Common Mode Rejection Ratio	$V_{CC} = \pm35V$ to $\pm5V$, $V_{CM} = \pm15V$		80		dB	1, 2, 3
$+V_{IO}$ Adj	Adjustment for Input Offset Voltage			4.0		mV	1, 2, 3
$-V_{IO}$ Adj	Adjustment for Input Offset Voltage				-4.0	mV	1, 2, 3
$+I_{OS}$	Output Short Circuit Current	$+V_{CC} = 15V$, $-V_{CC} = -15V$, $t \leq 25mS$, $V_{CM} = -15V$		-60		mA	1, 2, 3
$-I_{OS}$	Output Short Circuit Current	$+V_{CC} = 15V$, $-V_{CC} = -15V$, $t \leq 25mS$, $V_{CM} = +15V$			+60	mA	1, 2, 3
I_{CC}	Power Supply Current	$+V_{CC} = 15V$, $-V_{CC} = -15V$			3.0	mA	1
					2.32	mA	2
					3.5	mA	3
$\Delta V_{IO}/ \Delta T$	Temperature Coefficient of Input Offset Voltage	$-55°C \leq T_A \leq +25°C$	See[2]	-18	+18	µV/°C	2
		$+25°C \leq T_A \leq +125°C$	See[2]	-15	+15	uV/°C	3
$\Delta I_{IO} / \Delta T$	Temperature Coefficient of Input Offset Current	$-55°C \leq T_A \leq +25°C$	See[2]	-200	+200	pA/°C	2
		$+25°C \leq T_A \leq +125°C$	See[2]	-100	+100	pA/°C	3
$-A_{VS}$	Large Signal (Open Loop) Voltage Gain	$R_L = 2K\Omega$, $V_O = -15V$	See[3]	50		V/mV	4
			See[3]	25		V/mV	5, 6
		$R_L = 10K\Omega$, $V_O = -15V$	See[3]	50		V/mV	4
			See[3]	25		V/mV	5, 6
$+A_{VS}$	Large Signal (Open Loop) Voltage Gain	$R_L = 2K\Omega$, $V_O = +15V$	See[3]	50		V/mV	4
			See[3]	25		V/mV	5, 6
		$R_L = 10K\Omega$, $V_O = +15V$	See[3]	50		V/mV	4
			See[3]	25		V/mV	5, 6
A_{VS}	Large Signal (Open Loop) Voltage Gain	$V_{CC} = \pm5V$, $R_L = 2K\Omega$, $V_O = \pm2V$	See[3]	10		V/mV	4, 5, 6
		$V_{CC} = \pm5V$, $R_L = 10K\Omega$, $V_O = \pm2V$	See[3]	10		V/mV	4, 5, 6
$+V_{OP}$	Output Voltage Swing	$R_L = 10K\Omega$, $V_{CM} = -20V$		+16		V	4, 5, 6
		$RL = 2K\Omega$, $V_{CM} = -20V$		+15		V	4, 5, 6
$-V_{OP}$	Output Voltage Swing	$R_L = 10K\Omega$, $V_{CM} = 20V$			-16	V	4, 5, 6
		$R_L = 2K\Omega$, $V_{CM} = 20V$			-15	V	4, 5, 6

(2)   Calculated parameter
(3)   Datalog reading of K = V/mV.

LM101A QM and RH Electrical Characteristics AC Parameters

The following conditions apply to all parameters, unless otherwise specified
$V_{CC} = \pm20V$, $V_{CM} = 0V$, $R_S = 50\Omega$

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub-groups
+SR	Slew Rate	$A_V = 1$, $V_I = $ -5V to +5V		0.3		V/µS	7, 8A
				0.2		V/µS	8B
-SR	Slew Rate	$A_V = 1$, $V_I = $ +5V to -5V		0.3		V/µS	7, 8A
				0.2		V/µS	8B
TR_{TR}	Rise Time	$A_V = 1$, $V_I = 50mV$			800	nS	7, 8A, 8B
TR_{OS}	Overshoot	$A_V = 1$, $V_I = 50mV$			25	%	7
					35	%	8A, 8B
NI_{BB}	Noise Broadband	BW = 10Hz to 5KHz, $R_S = 0\Omega$			15	µV$_{RMS}$	7
NI_{PC}	Noise Popcorn	BW = 10Hz to 5KHz, $R_S = 100K\Omega$			80	µV$_{PK}$	7

LM101A   QM and RH Electrical Characteristics DC Parameters   Drift Values

The following conditions apply to all parameters, unless otherwise specified
$V_{CC} = \pm20V$, $V_{CM} = 0V$, $R_S = 50\Omega$
Delta calculations performed on QMLV devices at group B, Subgroup 5 only.

Symbol	Parameter	Conditions	Notes	Min	Max	Units	Sub-groups
V_{IO}	Input Offset Voltage	$V_{CM} = 0V$		-0.5	0.5	mV	1
$\pm I_{IB}$	Input Bias Current	$V_{CM} = 0V$, $R_S = 100K\Omega$		-7.5	7.5	nA	1

Product Folder Links: *LM101AQML*

Typical Performance Characteristics   LM101A

Input Voltage Range

Figure 4.

Output Swing

Figure 5.

Voltage Gain

Figure 6.

Supply Current

Figure 7.

Voltage Gain

Figure 8.

Maximum Power Dissipation
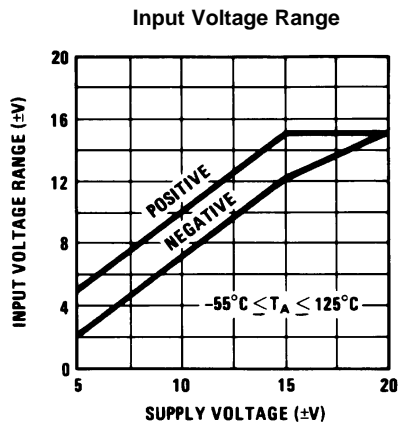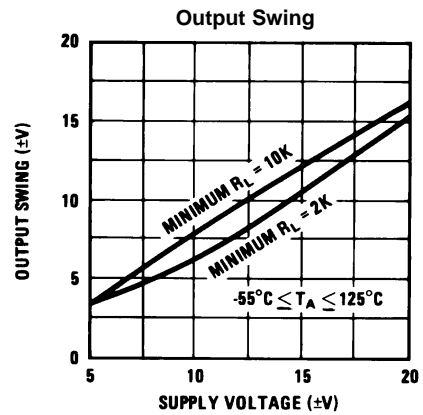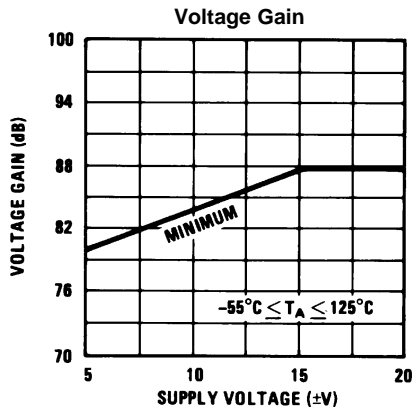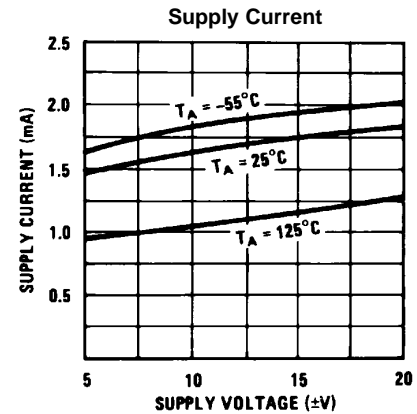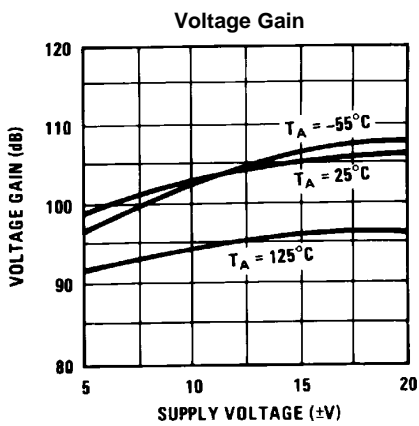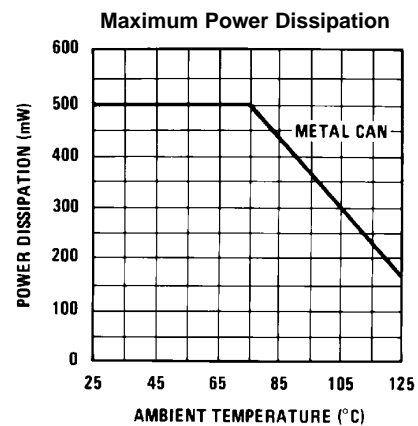
Figure 9.

Typical Performance Characteristics   LM101A (continued)
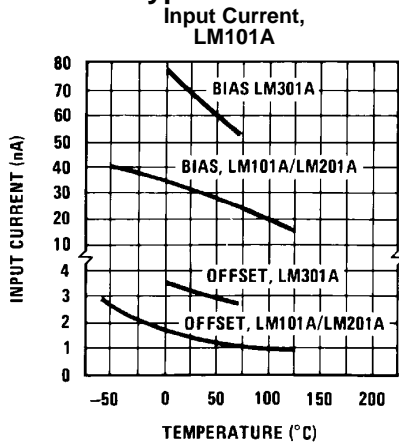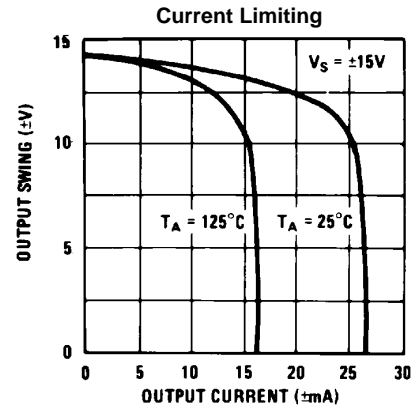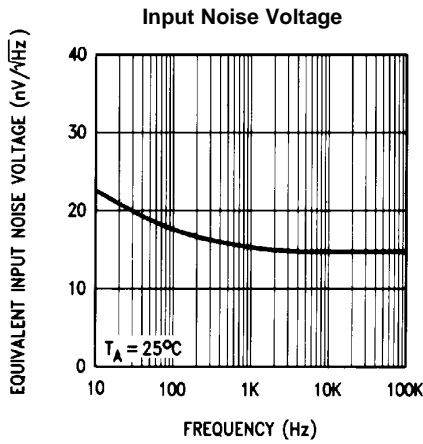
**Input Current,
LM101A**

Figure 10.

Current Limiting

Figure 11.

Input Noise Voltage

Figure 12.

Input Noise Current

Figure 13.

Common Mode Rejection

Figure 14.

Power Supply Rejection

Figure 15.

Product Folder Links: *LM101AQML*
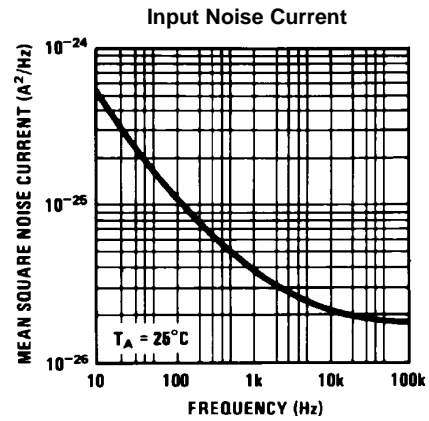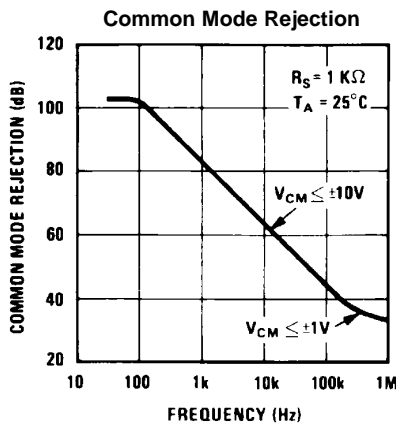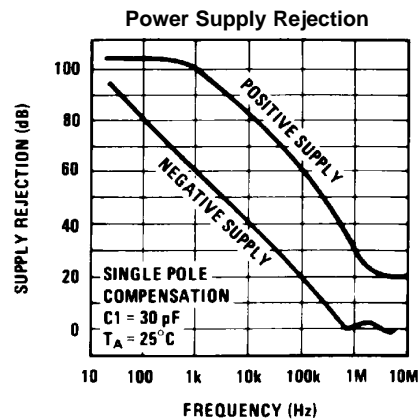
Typical Performance Characteristics   LM101A (continued)

**Closed Loop Output
Impedance**

Figure 16.

Submit Documentation Feedback   11

Product Folder Links: *LM101AQML*
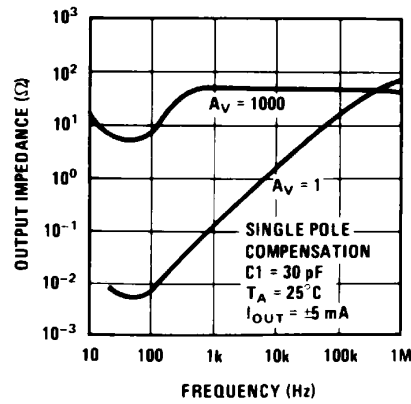
Typical Performance Characteristics for Various Compensation Circuits

Pin connections shown are for 8-pin packages.

Single Pole Compensation
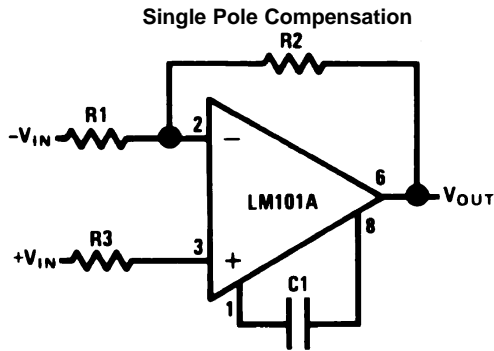
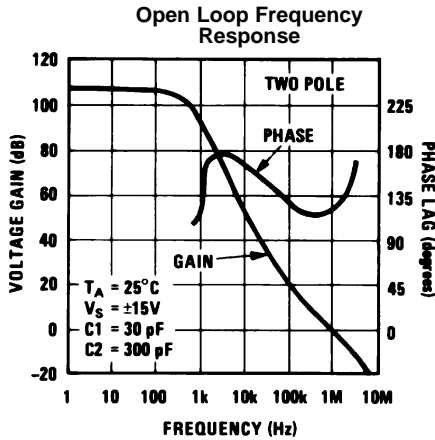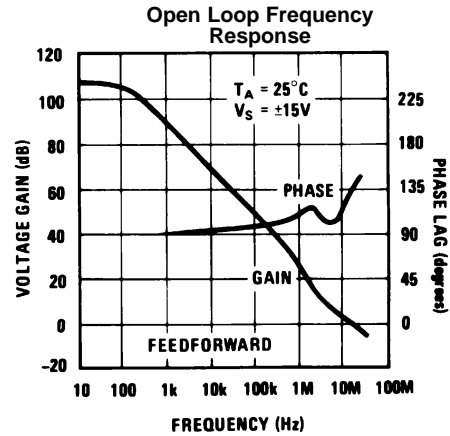
$$C1 \geq \frac{R1\ C_S}{R1 + R2}$$

$C_S = 30$ pF

Figure 17.

Two Pole Compensation
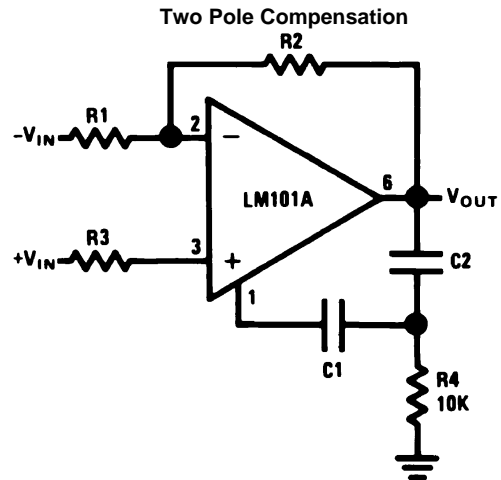
$$C1 \geq \frac{R1\ C_S}{R1 + R2}$$

$C_S = 30$ pF
$C2 = 10\ C1$

Figure 18.

Feedforward Compensation
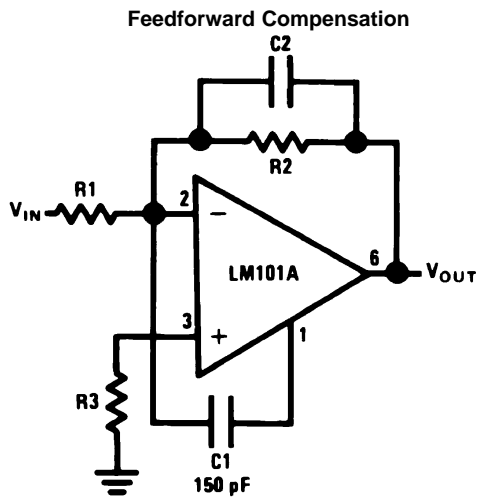
$$C2 = \frac{1}{2\pi\ f_o\ R2}$$

$f_o = 3$ MHz

Figure 19.
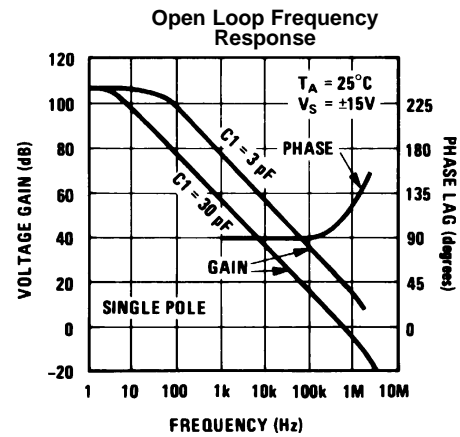
Open Loop Frequency Response

Figure 20.

Product Folder Links: *LM101AQML*

Typical Performance Characteristics for Various Compensation Circuits (continued)

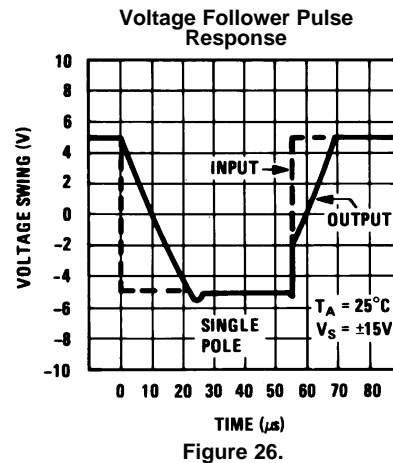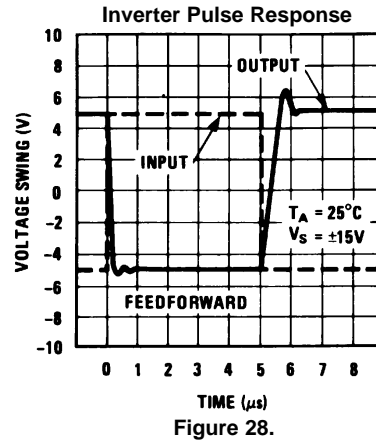Pin connections shown are for 8-pin packages.

Figure 21.

Figure 22.
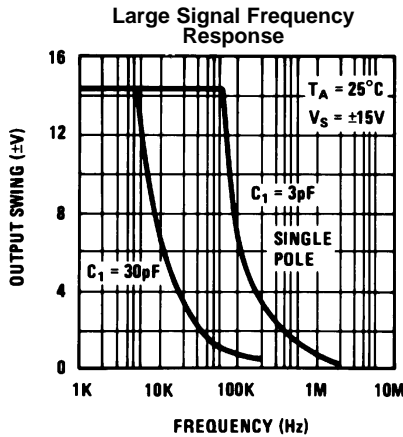
Figure 23.
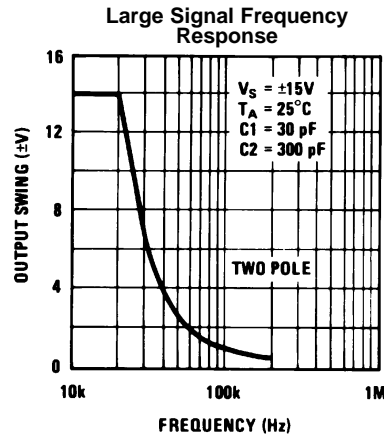
Figure 24.
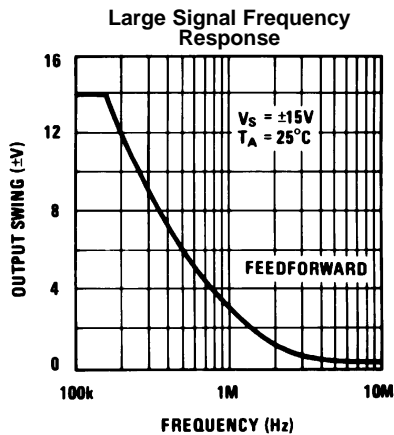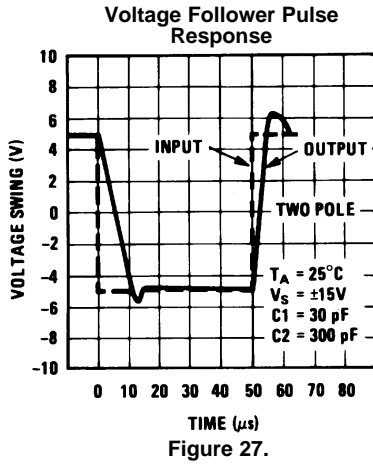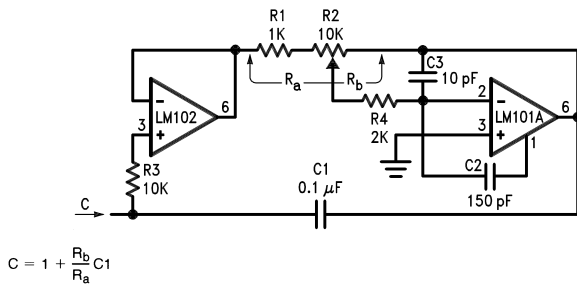

Figure 25.

Figure 26.

Product Folder Links: *LM101AQML*

Typical Performance Characteristics for Various Compensation Circuits (continued)

Pin connections shown are for 8-pin packages.

Voltage Follower Pulse Response

Figure 27.

Inverter Pulse Response

Figure 28.

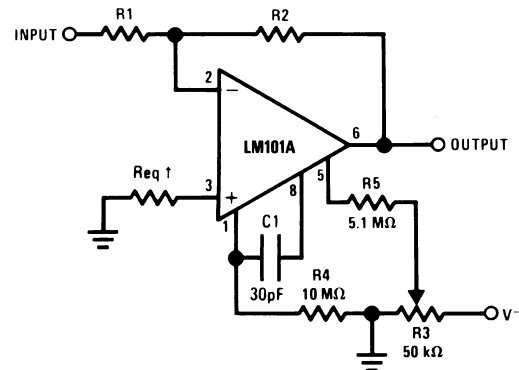Product Folder Links: *LM101AQML*

TYPICAL APPLICATIONS
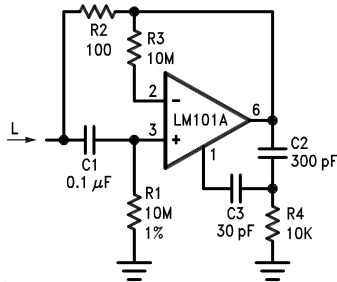
Pin connections shown are for 8-pin packages.

$$C = 1 + \frac{R_b}{R_a} C1$$

Figure 29. Variable Capacitance Multiplier

†May be zero or equal to parallel combination of R1 and R2 for minimum offset.
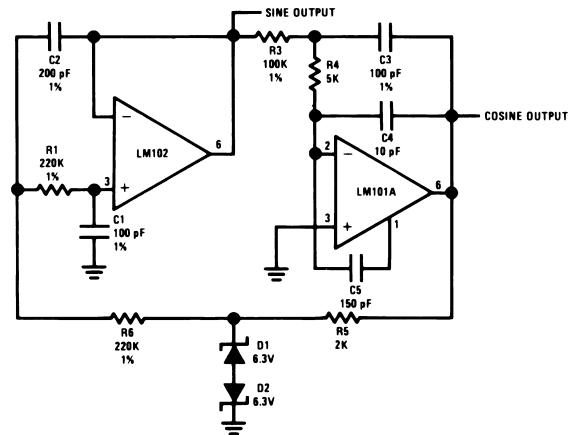
Figure 30. Inverting Amplifier with Balancing Circuit

$L \simeq R1\ R2\ C1$
$R_S = R2$
$R_P = R1$

Figure 31. Simulated Inductor

$f_o = 10$ kHz
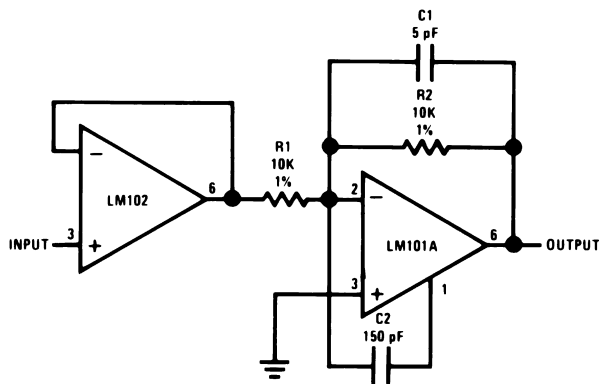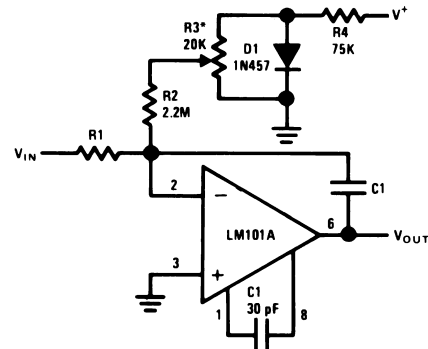
Figure 32. Sine Wave Oscillator

Figure 33. Fast Inverting Amplifier with High Input Impedance

*Adjust for zero integrator drift. Current drift typically 0.1 nA/°C over −55°C to +125°C temperature range.

Figure 34. Integrator with Bias Current Compensation

Application Hints
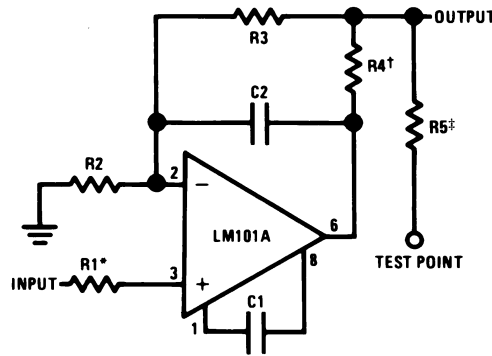
*Protects input
†Protects output
‡Protects output—not needed when R4 is used.

Figure 35. Protecting Against Gross Fault Conditions

$$C2 = \frac{R1\, C_S}{R2}$$

Figure 36. Compensating for Stray Input Capacitances or Large Feedback Resistor

Figure 37. Isolating Large Capacitive Loads

Product Folder Links: *LM101AQML*

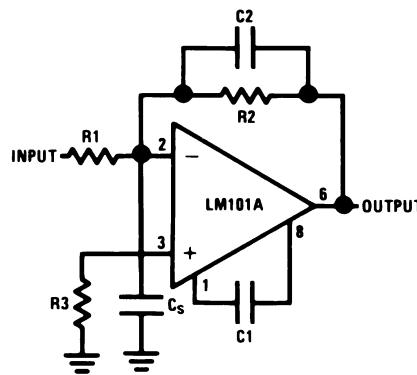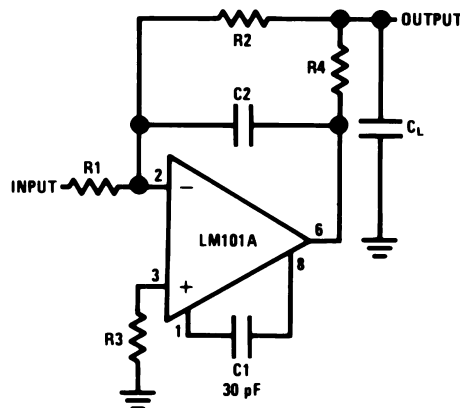Although the LM101A is designed for trouble free operation, experience has indicated that it is wise to observe certain precautions given below to protect the devices from abnormal operating conditions. It might be pointed out that the advice given here is applicable to practically any IC op amp, although the exact reason why may differ with different devices.

When driving either input from a low-impedance source, a limiting resistor should be placed in series with the input lead to limit the peak instantaneous output current of the source to something less than 100 mA. This is especially important when the inputs go outside a piece of equipment where they could accidentally be connected to high voltage sources. Large capacitors on the input (greater than 0.1 µF) should be treated as a low source impedance and isolated with a resistor. Low impedance sources do not cause a problem unless their output voltage exceeds the supply voltage. However, the supplies go to zero when they are turned off, so the isolation is usually needed.

The output circuitry is protected against damage from shorts to ground. However, when the amplifier output is connected to a test point, it should be isolated by a limiting resistor, as test points frequently get shorted to bad places. Further, when the amplifier drives a load external to the equipment, it is also advisable to use some sort of limiting resistance to preclude mishaps.

Precautions should be taken to insure that the power supplies for the integrated circuit never become reversed—even under transient conditions. With reverse voltages greater than 1V, the IC will conduct excessive current, fusing internal aluminum interconnects. If there is a possibility of this happening, clamp diodes with a high peak current rating should be installed on the supply lines. Reversal of the voltage between V^+ and V^- will always cause a problem, although reversals with respect to ground may also give difficulties in many circuits.

The minimum values given for the frequency compensation capacitor are stable only for source resistances less than 10 kΩ, stray capacitances on the summing junction less than 5 pF and capacitive loads smaller than 100 pF. If any of these conditions are not met, it becomes necessary to overcompensate the amplifier with a larger compensation capacitor. Alternately, lead capacitors can be used in the feedback network to negate the effect of stray capacitance and large feedback resistors or an RC network can be added to isolate capacitive loads.

Although the LM101A is relatively unaffected by supply bypassing, this cannot be ignored altogether. Generally it is necessary to bypass the supplies to ground at least once on every circuit card, and more bypass points may be required if more than five amplifiers are used. When feed-forward compensation is employed, however, it is advisable to bypass the supply leads of each amplifier with low inductance capacitors because of the higher frequencies involved.

Typical Applications

Pin connections shown are for 8-pin packages.

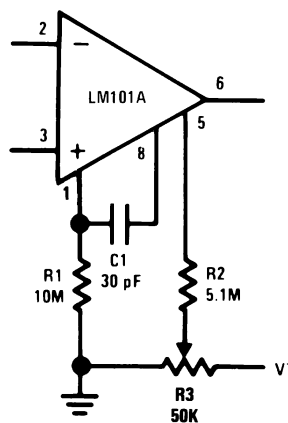**Figure 38. Standard Compensation and Offset Balancing Circuit**
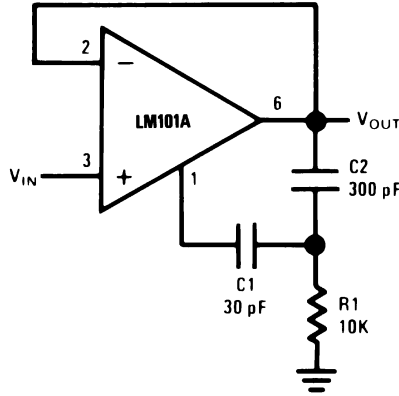
Power Bandwidth: 15 kHz
Slew Rate: 1V/µs

Figure 39. Fast Voltage Follower
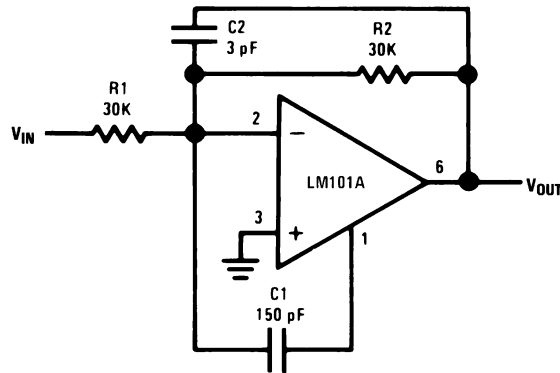
Power Bandwidth: 250 kHz
Small Signal Bandwiidth: 3.5 MHz
Slew Rate: 10V/µs

Figure 40. Fast Summing Amplifier
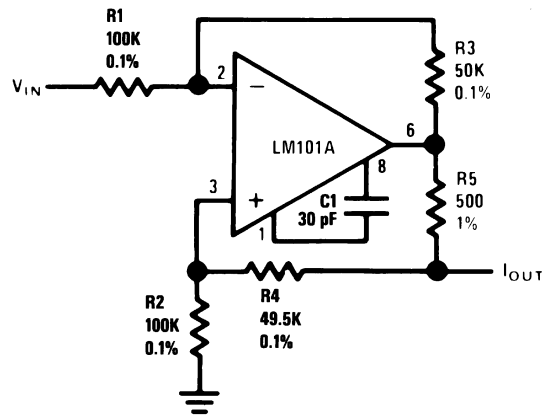
$$I_{OUT} = \frac{R3\ V_{IN}}{R1\ R5}$$

R3 = R4 + R5
R1 = R2

Figure 41. Bilateral Current Source
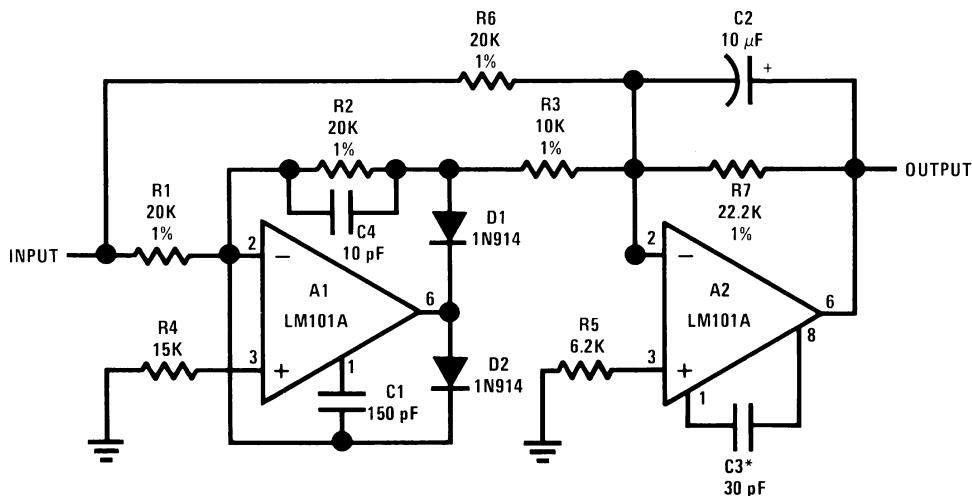
Product Folder Links: *LM101AQML*

Note: Feedforward compensation can be used to make a fast full wave rectifier without a filter.

Figure 42. Fast AC/DC Converter
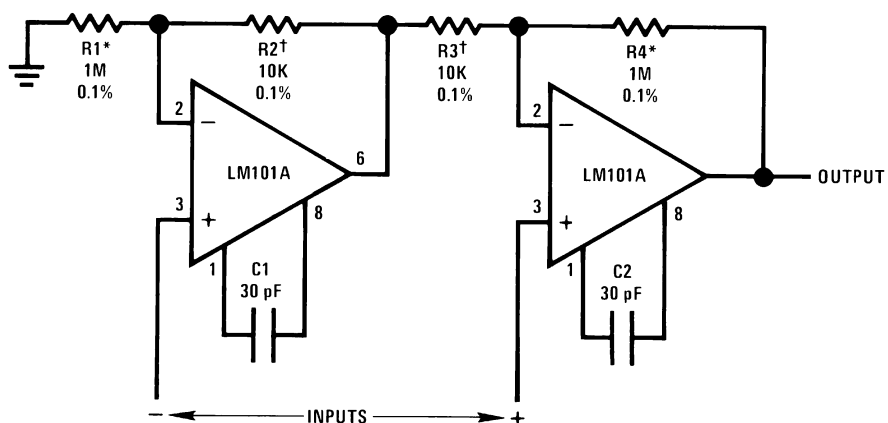
R1 = R4; R2 = R3

$$A_V = 1 + \frac{R1}{R2}$$

*,† Matching determines CMRR.

Figure 43. Instrumentation Amplifier
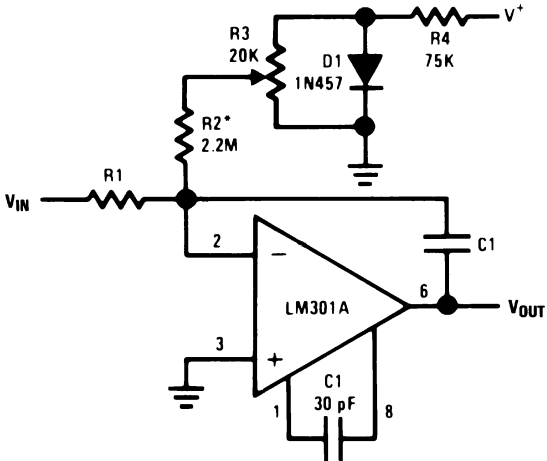
*Adjust for zero integrator drift. Current drift typically 0.1 nA/°C over 0°C to +70°C temperature range.

Figure 44. Integrator with Bias Current Compensation
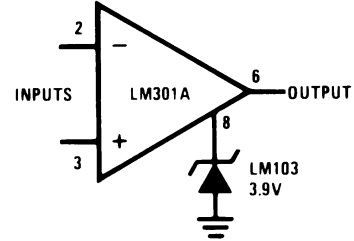
Figure 45. Voltage Comparator for Driving RTL Logic or High Current Driver
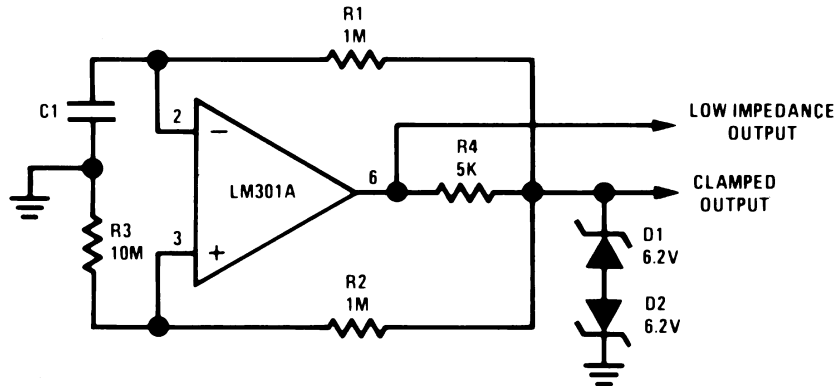
Figure 46. Low Frequency Square Wave Generator
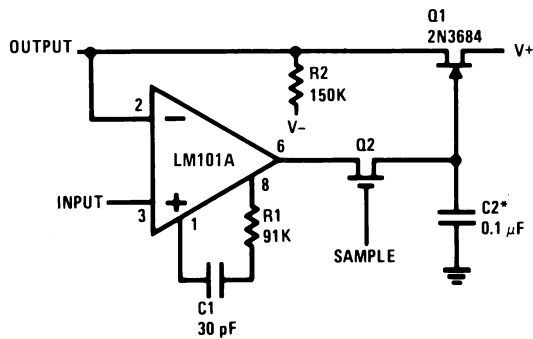
*Polycarbonate-dielectric capacitor

Figure 47. Low Drift Sample and Hold
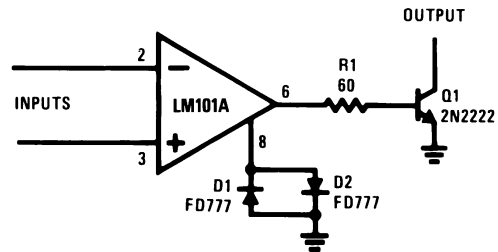
Figure 48. Voltage Comparator for Driving DTL or TTL Integrated Circuits

Product Folder Links: *LM101AQML*

LM101AQML

REVISION HISTORY SECTION

Date Released	Revision	Section	Originator	Changes
01/05/06	A	New Release to corporate format	L. Lytle	2 MDS datasheets converted into one Corp. datasheet format. MNLM101A-X Rev 0A0 and MRLM101A-X-RH rev 1C2 MDS datasheets will be archived.
03/20/13	A	All	-	Changed layout of National Data Sheet to TI format

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead/Ball Finish	MSL Peak Temp (3)	Op Temp (°C)	Top-Side Markings (4)	Samples
5962L9951501VGA	ACTIVE	TO-99	LMC	8	20	TBD	Call TI	Call TI	-55 to 125	LM101AHLQMLV 5962L9951501VGA Q ACO 5962L9951501VGA Q >T	Samples
5962L9951501VHA	ACTIVE	CFP	NAD	10	19	TBD	Call TI	Call TI	-55 to 125	LM101AW LQMLV Q 5962L99515 01VHA ACO 01VHA >T	Samples
5962L9951501VPA	ACTIVE	CDIP	NAB	8	40	TBD	Call TI	Call TI	-55 to 125	LM101AJLQMLV 5962L99515 01VPA Q ACO 01VPA Q >T	Samples
LM101AH/883	ACTIVE	TO-99	LMC	8	20	TBD	Call TI	Call TI	-55 to 125	LM101AH/883 Q ACO LM101AH/883 Q >T	Samples
LM101AHLQMLV	ACTIVE	TO-99	LMC	8	20	TBD	Call TI	Call TI	-55 to 125	LM101AHLQMLV 5962L9951501VGA Q ACO 5962L9951501VGA Q >T	Samples
LM101AJ/883	ACTIVE	CDIP	NAB	8	40	TBD	Call TI	Call TI	-55 to 125	(LF412MJ ~ LM101AJ) /883 Q ACO /883 Q >T	Samples
LM101AJLQMLV	ACTIVE	CDIP	NAB	8	40	TBD	Call TI	Call TI	-55 to 125	LM101AJLQMLV 5962L99515 01VPA Q ACO 01VPA Q >T	Samples
LM101AWLQMLV	ACTIVE	CFP	NAD	10	19	TBD	Call TI	Call TI	-55 to 125	LM101AW LQMLV Q 5962L99515 01VHA ACO 01VHA >T	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

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NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.
TBD: The Pb-Free/Green conversion plan has not been defined.
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Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.
Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) Multiple Top-Side Markings will be inside parentheses. Only one Top-Side Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Top-Side Marking for that device.

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● Military: LM101AQML

● Space: LM101AQML-SP

NOTE: Qualified Version Definitions:

 ● Military - QML certified for Military and Defense Applications

 ● Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

NAB0008A

.400 MAX
[10.16]

8

5

.310 MAX
[7.87]

R.025
[0.64]
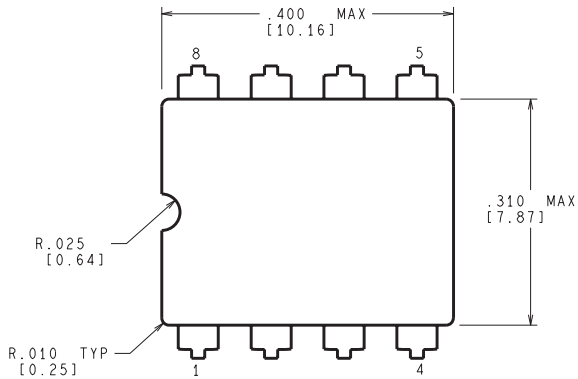
CONTROLLING DIMENSION IS INCH
VALUES IN [ ] ARE MILLIMETERS

R.010 TYP
[0.25]

1

4

8X .055±.010
[1.4±0.25]

.290-.320
[7.37-8.13]

GLASS SEALANT

.200 MAX TYP
[5.08]

.180 MAX
[4.57]

8X .125-.200
[3.18-5.08]

90° ±4°
TYP

.020-.060
[0.51-1.52]
TYP

95° ±5°
TYP

8X .010±.002
[0.25±0.05]

.055 MAX TYP
[1.40]

6X .100±.010
[2.54±0.25]

8X .018±.003
[0.46±0.07]

.310-.410
[7.87-10.41]

J08A (Rev M)

TEXAS INSTRUMENTS
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NAD0010A

.067 +.013 -.012

.045
.026

.005 MIN TYP

.27 MAX

10   6

5X .32±.01

.27 MAX
GLASS

.241 +.019 -.003

PIN #1 ID

5X .32±.01

1   5

.010±.002

10X .017±.002

.045 MAX TYP

8X .050±.005

.005±.001 TYP

DIMENSIONS ARE IN INCHES

W10A (Rev H)

LMC (O−MBCY−W8)   METAL CYLINDRICAL PACKAGE

ϕ $\dfrac{0.370\ (9,40)}{0.335\ (8,51)}$

ϕ $\dfrac{0.335\ (8,51)}{0.305\ (7,75)}$

$\dfrac{0.040\ (1,02)}{0.010\ (0,25)}$

$\dfrac{0.185\ (4,70)}{0.165\ (4,19)}$

0.040 (1,02) MAX

Seating Plane

0.500 (12,70) MIN

ϕ $\dfrac{0.021\ (0,53)}{0.016\ (0,41)}$

$\dfrac{0.105\ (2,67)}{0.095\ (2,41)}$

ϕ $\dfrac{0.160\ (4,06)}{0.110\ (2,79)}$

$\dfrac{0.105\ (2,67)}{0.095\ (2,41)}$

0.200 (5,08)a

$\dfrac{0.034\ (0,86)}{0.028\ (0,71)}$

45°

$\dfrac{0.045\ (1,14)}{0.029\ (0,74)}$

4202483/B 09/07
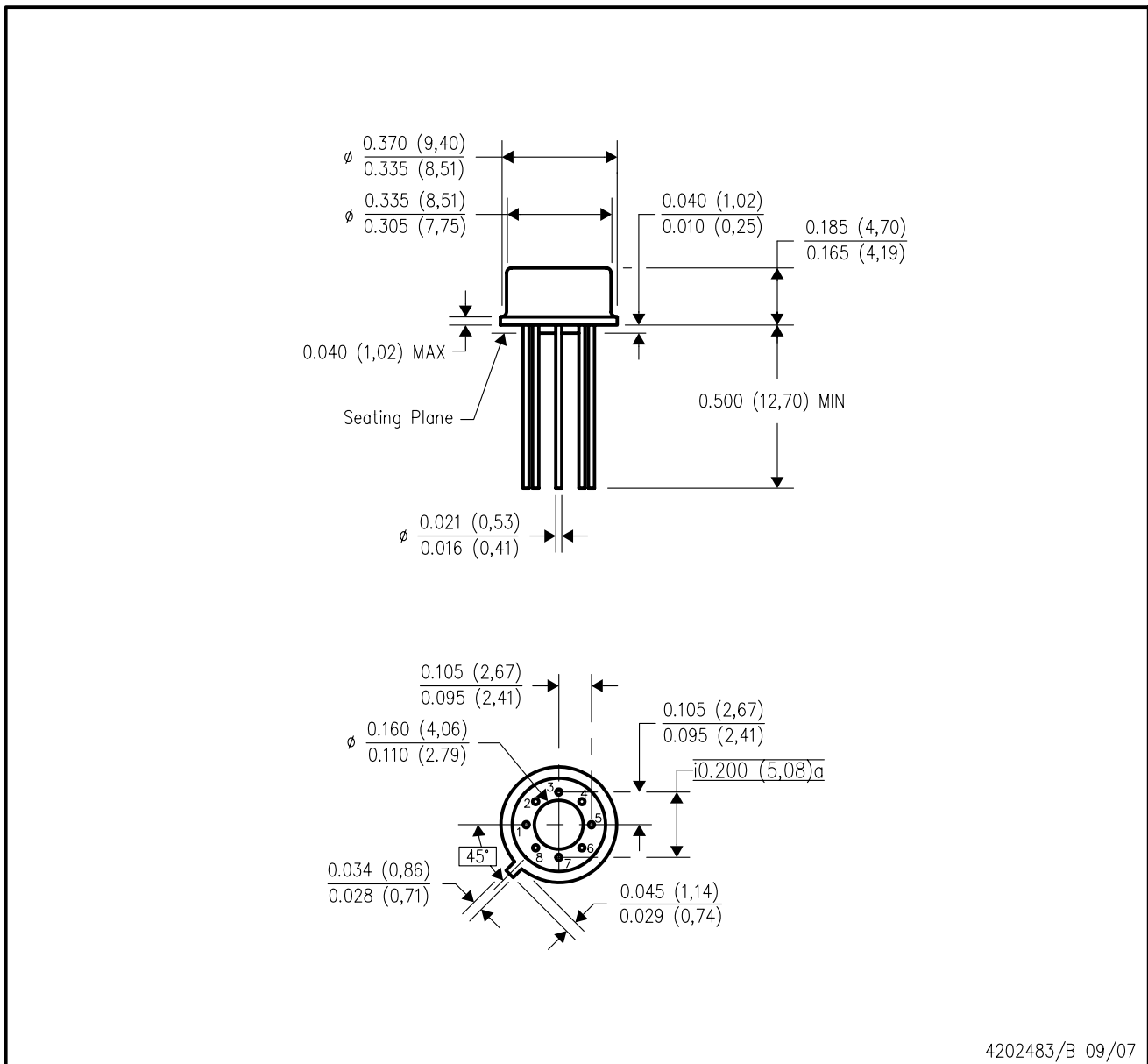
NOTES: A. All linear dimensions are in inches (millimeters).
        B. This drawing is subject to change without notice.
        C. Leads in true position within 0.010 (0,25) R @ MMC at seating plane.
        D. Pin numbers shown for reference only. Numbers may not be marked on package.
        E. Falls within JEDEC MO−002/TO−99.

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RFID	www.ti-rfid.com		
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